

Dual N-channel field-effect transistor

Rev. 3 — 6 March 2014

**Product data sheet** 

## 1. Product profile

### 1.1 General description

Two N-channel symmetrical junction field-effect transistors in a SOT363 package.

#### CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

### **1.2 Features and benefits**

- Two field effect transistors in a single package
- Low noise
- Interchangeability of drain and source connections
- High gain.

### **1.3 Applications**

- AM input stage in car radios
- VHF amplifiers
- Oscillators and mixers.

### 1.4 Quick reference data

#### Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per FET	1				<b>I</b>	
V <sub>DS</sub>	drain-source voltage		-	-	±25	V
V <sub>GSoff</sub>	gate-source cut-off voltage	$V_{DS} = 10 \text{ V}; \text{ I}_{D} = 1 \mu\text{A}$	-2	-	-6.5	V
I <sub>DSS</sub>	drain current	$V_{GS} = 0 V; V_{DS} = 10 V$	24	-	60	mA
P <sub>tot</sub>	total power dissipation	T <sub>s</sub> ≤ 90 °C	-	-	190	mW
y <sub>fs</sub>	forward transfer admittance	$V_{DS} = 10 \text{ V};$ $I_D = 10 \text{ mA}$	10	-	-	mS



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#### **Pinning information** 2.

Pin	Description	Simplified outline	Symbol
1	source (1)		
2	source (2)		
3	gate (2)		
4	drain (2)		3
5	drain (1)	∐1 ∐2 ∐3	sym034
6	gate (1)		

#### **Ordering information** 3.

Table 3. Ordering information					
Type number	Package				
	Name	Description	Version		
PMBFJ620	-	plastic surface-mounted package; 6 leads	SOT363		

#### Marking 4.

#### Table 4. Marking

5	
Type number	Marking code [1]
PMBFJ620	A8*

[1] \* = p: made in Hong Kong. \* = t: made in Malaysia.

\* = W: made in China.

#### **Dual N-channel field-effect transistor**

## 5. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

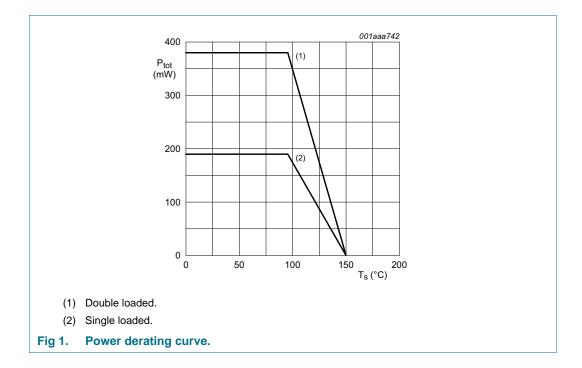
Symbol	Parameter	Conditions	Min	Max	Unit
Per FET				I	
V <sub>DS</sub>	drain-source voltage		-	±25	V
V <sub>GSO</sub>	gate-source voltage	open drain	-	-25	V
V <sub>GDO</sub>	gate-drain voltage	open source	-	-25	V
l <sub>G</sub>	forward gate current (DC)		-	50	mA
P <sub>tot</sub>	total power dissipation	$T_s \le 90 \ ^\circ C$	-	190	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C

### 6. Thermal characteristics

#### Table 6.Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
11(10)	,	single loaded [1]	315	K/W
	to soldering points	double loaded [1]	160	K/W

[1]  $T_s$  is the temperature at the soldering point of the gate pins, see Figure 1.



## 7. Static characteristics

#### Table 7. Characteristics

 $T_i = 25 \ ^{\circ}C$  unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per FET						
V <sub>(BR)GSS</sub>	gate-source breakdown voltage	$I_G = -1 \ \mu A; \ V_{DS} = 0 \ V$	-25	-	-	V
V <sub>GSoff</sub>	gate-source cut-off voltage	$I_D = 1 \ \mu A; \ V_{DS} = 10 \ V$	-2	-	-6.5	V
V <sub>GSS</sub>	gate-source forward voltage	$I_{G} = 1 \text{ mA}; V_{DS} = 0 \text{ V}$	-	-	1	V
I <sub>DSS</sub>	drain-source leakage current	$V_{DS} = 10 \text{ V}; V_{GS} = 0 \text{ V}$	24	-	60	mA
I <sub>GSS</sub>	gate-source leakage current	$V_{GS} = -15 \text{ V}; V_{DS} = 0 \text{ V}$	-	-	-1	nA
R <sub>DSon</sub>	drain-source on-state resistance	$V_{GS} = 0 V; V_{DS} = 100 mV$	-	50	-	Ω
y <sub>fs</sub>	common source forward transfer admittance	I <sub>D</sub> = 10 mA; V <sub>DS</sub> = 10 V	10	-	-	mS
y <sub>os</sub>	common source output admittance	$I_D = 10 \text{ mA}; V_{DS} = 10 \text{ V}$	-	-	250	μS

## 8. Dynamic characteristics

#### Table 8. Characteristics

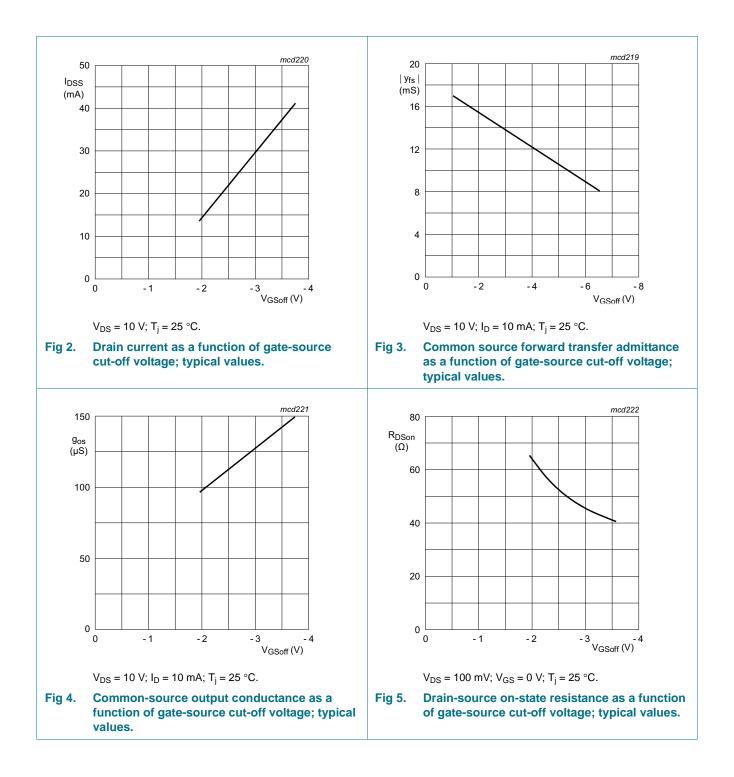
 $T_i = 25 \ ^{\circ}C$  unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per FET						
C <sub>iss</sub>	input capacitance	$V_{DS}$ = 10 V; $V_{GS}$ = -10 V; f =1 MHz	-	3	5	pF
		$V_{DS}$ = 10 V; $V_{GS}$ = 0 V; $T_{amb}$ = 25 °C	-	6	-	pF
C <sub>rss</sub>	reverse transfer capacitance	$V_{DS} = 0 V; V_{GS} = -10 V; f = 1 MHz$	-	1.3	2.5	pF
g <sub>is</sub> common source input conductance	$V_{DS}$ = 10 V; I <sub>D</sub> = 10 mA; f = 100 MHz	-	200	-	μS	
	conductance	$V_{DS}$ = 10 V; I <sub>D</sub> = 10 mA; f = 450 MHz	-	3	-	mS
g <sub>fs</sub> common source transfer	common source transfer	$V_{DS}$ = 10 V; I <sub>D</sub> = 10 mA; f = 100 MHz	-	13	-	mS
	conductance	$V_{DS} = 10 \text{ V}; I_D = 10 \text{ mA}; f = 450 \text{ MHz}$	-	12	-	mS
<b>g</b> <sub>rs</sub>	common source reverse	$V_{DS}$ = 10 V; I <sub>D</sub> = 10 mA; f = 100 MHz	-	-30	-	μS
	conductance	$V_{DS} = 10 \text{ V}; I_D = 10 \text{ mA}; f = 450 \text{ MHz}$	-	-450	-	μS
<b>g</b> os	common source output	$V_{DS} = 10 \text{ V}; I_D = 10 \text{ mA}; f = 100 \text{ MHz}$	-	150	-	μS
	conductance	$V_{DS} = 10 \text{ V}; I_D = 10 \text{ mA}; f = 450 \text{ MHz}$	-	400	-	μS
Vn	equivalent input noise voltage	V <sub>DS</sub> = 10 V; I <sub>D</sub> = 10 mA; f = 100 Hz	-	6	-	nV/√Hz

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# PMBFJ620

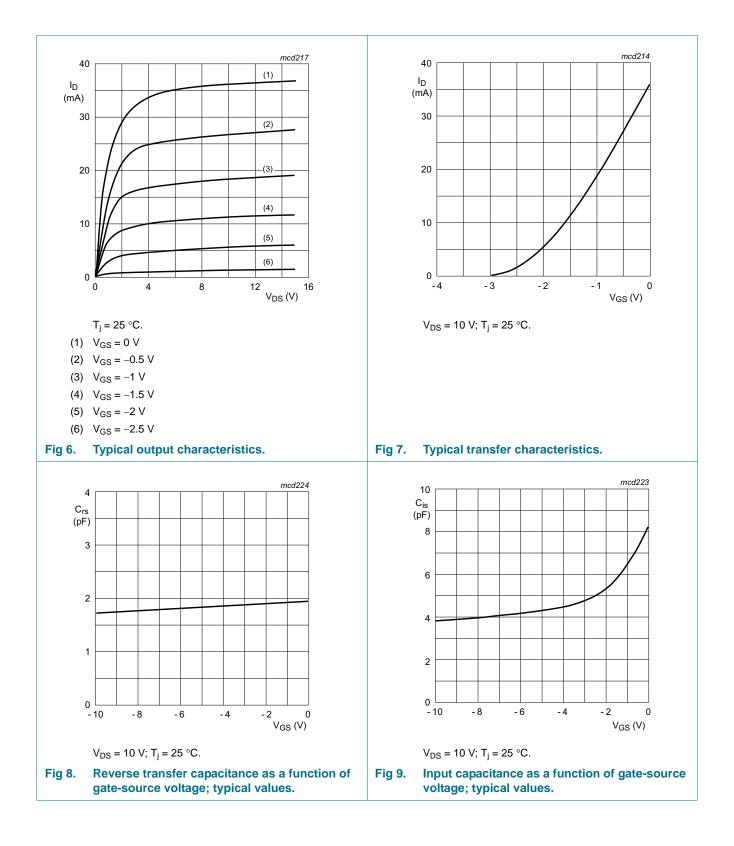
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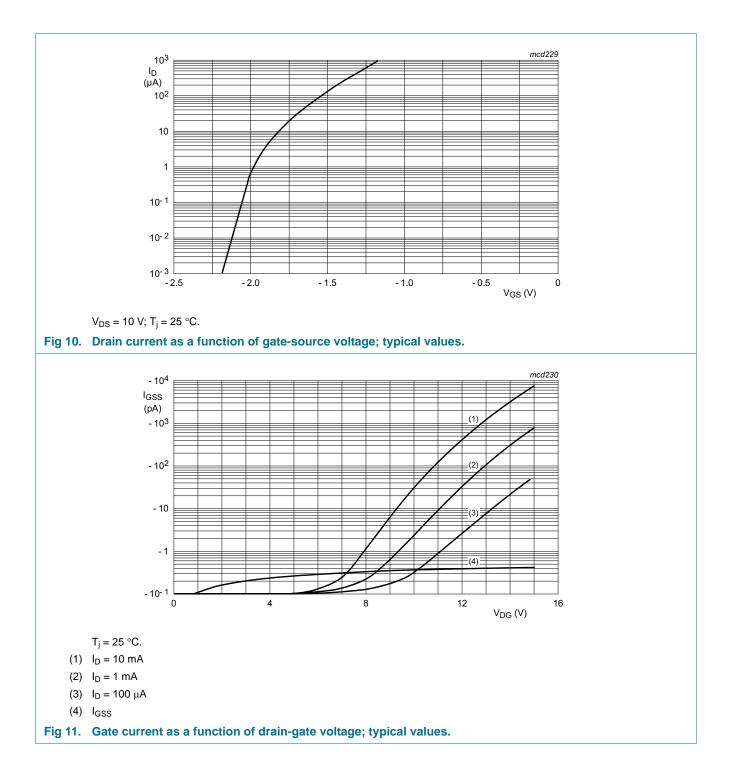
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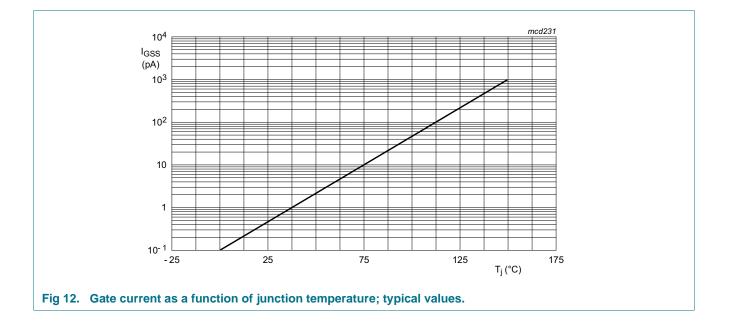
#### **Dual N-channel field-effect transistor**



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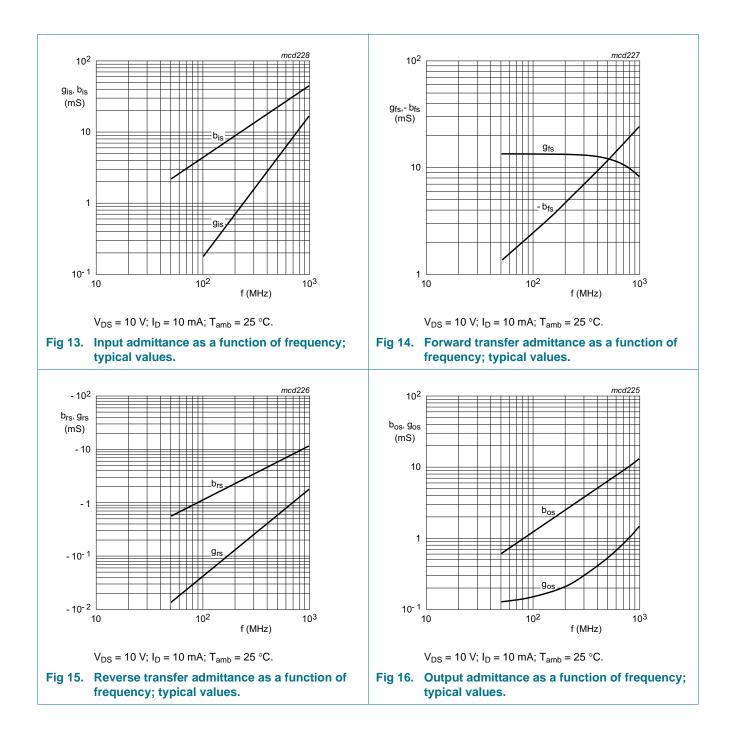
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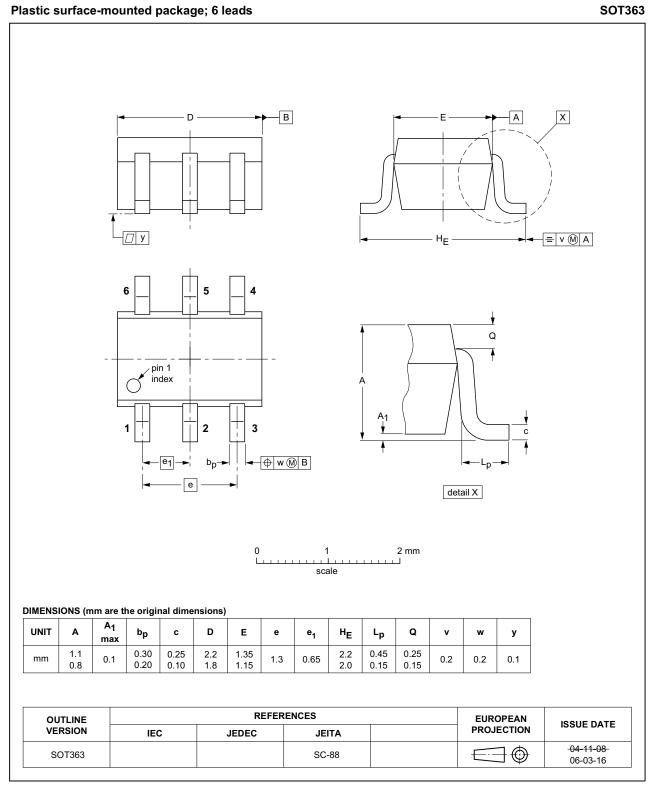
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**Dual N-channel field-effect transistor** 

### 9. Package outline



#### Fig 17. Package outline.

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### Dual N-channel field-effect transistor

## **10. Revision history**

#### Table 9. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PMBFJ620 v.3	20140306	Product data sheet	-	PMBFJ620 v.2
Modifications:	• Table 5 on p	age 3: correction parameter V <sub>G</sub>	BDO	
	Figure 6 on	page 6: figure notes list added		
	Figure 11 on	page 7: figure notes list added	l	
PMBFJ620 v.2	20110915	Product data sheet	-	PMBFJ620 v.1
PMBFJ620 v.1 (9397 750 13006)	20040511	Product data sheet	-	-

### **11. Legal information**

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Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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